Synthesis and Microwave Dielectric Properties of MgO-TiO₂-SiO₂ Ceramics

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Abstract—The dielectric properties of $MgO-TiO_2-SiO_2$ ceramics were studied. The results demonstrate that the presence of $MgTi_2O_5$ increases dielectric losses in the ceramics. The synthesized materials offer low microwave losses and temperature-stable permittivity in the range 10–20.

INTRODUCTION

Advances in wireless applications are highly dependent on the development of new low-loss (high $Q=1/\tan\delta$) microwave materials [1–3]. Availability of high-Q ($Qf \approx 10^5$ GHz) dielectrics with temperature coefficients of permittivity (TCP = $\frac{1}{\epsilon} \frac{\partial \epsilon}{\partial T}$) on the order

of 10⁻⁶ K⁻¹ is critical for GHz applications. Considerable research effort has been recently concentrated on the development of temperature-stable high-*Q* dielectrics with permittivity in the range 10 to 20 [4, 5]. The use of such materials in filters and generators for communication systems offers the possibility of enhancing their sensitivity and selectivity [6, 7].

High-Q dielectrics with $\varepsilon=10$ –20 can be prepared using MgO–SiO₂ and MgO–TiO₂ oxides [8, 9]. The compounds existing in these systems include magnesium meta- and orthosilicates (MgSiO₃, Mg₂SiO₄), magnesium meta- and orthotitanates (MgTiO₃, Mg₂TiO₄), and magnesium dititanate (MgTi₂O₅).

Materials based on Mg_2SiO_4 , $MgTiO_3$, and Mg_2TiO_4 are considered potentially attractive for designing low-TCP microwave dielectrics [6–9]. Available data on their microwave dielectric losses are however contradictory. For example, the Qf values reported for $MgTiO_3$ -based materials range from 3×10^4 to 10^5 GHz [7–9], indicating that the chemical composition of the material and synthesis conditions have a significant effect on its microwave losses.

There are also problems arising from the high (>1500°C) sintering temperatures of polycrystalline materials based on magnesium titanates and silicates. To obviate this difficulty, use has been made of various additives and fluxes [8–10]. It is reasonable to expect that a viable approach to the fabrication of dense

ceramics at relatively low (<1400°C) sintering temperatures is the use of multicomponent magnesium silicate and titanate systems. Moreover, since the dielectric permittivity of Mg_2SiO_4 is 6.5 [10] and those of $MgTiO_3$ and Mg_2TiO_4 are 16 and 14, respectively [10], one can engineer controlled-permittivity materials by tuning the phase composition of the system.

The objective of this work was to prepare low-loss, low-TCP microwave ceramics based on compounds of the MgO–TiO₂–SiO₂ system. To this end, we examined the effects of starting-mixture composition and heat-treatment temperature on the phase composition of (1 - x)Mg₂SiO₄–xMgTiO₃ and (1 - x)Mg₂SiO₄–xMg₂TiO₄ (x = 0, 0.25, 0.5, 0.75, 1) ceramics and also the effect of phase composition on the dielectric properties of the ceramics.

EXPERIMENTAL

Samples for this investigation were prepared by solid-state reactions, using analytical-grade MgO and MgCO₃ and extrapure-grade SiO₂ and TiO₂. The starting mixtures were homogenized by ball milling with bidistilled water. After evaporating the residual water, the mixtures were dried at 100-150°C, passed through a nylon-6 sieve, and pressed at 50 MPa into pellets, which were then fired at 600-1400°C. After heat treatment, the samples were ground, and their phase compositions were determined by x-ray diffraction (XRD) on a DRON-3M powder diffractometer (CuK_{α} radiation, step-scan mode with a step size $\Delta 2\theta = 0.02^{\circ}$ and a counting time per data point of 10 s). As external standards, we used SiO₂ (20 calibration) and Al₂O₃ (NIST SRM1976 intensity standard). In phase analysis, we used JCPDS Powder Diffraction File data.

 ${
m Mg_2SiO_4}$, ${
m MgTiO_3}$, and ${
m Mg_2TiO_4}$ were prepared by reacting appropriate mixtures at 1150–1200°C for 2 h. To obtain ceramic samples, the synthesized materials were pressed into pellets 10 mm in diameter and 3–4 mm in thickness and sintered at $t_{\rm sint} = 1300$ –1400°C for 2 h. Microwave measurements were performed at 10 GHz using the dielectric-resonator method [11–13].

RESULTS AND DISCUSSION

To optimize the synthesis temperatures for Mg_2SiO_4 , $MgTiO_3$, and Mg_2TiO_4 , we examined the phase changes involved in the formation of these compounds. XRD results indicated that, irrespective of whether MgO or $MgCO_3$ was used as the Mg precursor, the formation of Mg_2SiO_4 began at $1000^{\circ}C$ (Fig. 1). With both precursors, the samples synthesized at $1150-1200^{\circ}C$ contained trace levels of additional phases: $MgSiO_3$ (protoenstatite) and MgO. In the case of MgO, however, the percentages of these phases were substantially smaller (Fig. 1, scan 2). Note that protoenstatite transforms into clinoenstatite at $t \ge 1200^{\circ}C$. At heat-treatment temperatures above $1300^{\circ}C$, we obtained phase-pure Mg_2SiO_4 (Fig. 1, scan 3).

The formation of MgTiO₃ from equimolar mixtures of MgO and TiO₂ occurred in the range 800–1000°C. Heat treatment above 1000°C led to the formation of phase-pure MgTiO₃ (Fig. 2, scan 2). In the range 1300–1400°C (sintering temperatures), a small amount of MgTiO₃ decomposed to form Mg₂TiO₄ (Fig. 2, scan 3).

The formation of Mg₂TiO₄ required higher temperatures in comparison with MgTiO₃. The material prepared by reacting a 2MgO + TiO₂ mixture at 1000°C contained not only Mg₂TiO₄ but also MgTiO₃, TiO₂, MgO, and a small amount of MgTi₂O₅, resulting from the reaction between MgTiO₃ and TiO₂ (Fig. 3, scan *I*). At 1200–1300°C, the MgTiO₃ and MgO reacted to form Mg₂TiO₄ (Fig. 3, scan 2). Phase-pure Mg₂TiO₄ was obtained in the range 1300–1400°C (sintering temperatures) (Fig. 3, scan *3*).

XRD results for $(1 - x)Mg_2SiO_4-xMg_2TiO_4$ (x = 0.25, 0.5, 0.75) samples indicated than no reaction took place at 1350°C (Fig. 4). Independent of x, the only phases present were Mg_2SiO_4 and Mg_2TiO_4 .

XRD examination of $(1 - x)Mg_2SiO_4$ – $xMgTiO_3$ samples indicated the presence of Mg_2SiO_4 , $MgTiO_3$, and $MgTi_2O_5$ (Fig. 5). At x < 0.25, no $MgTi_2O_5$ was detected.

Dielectric measurements showed that the synthesized Mg_2SiO_4 , $MgTiO_3$, and Mg_2TiO_4 had positive TCP, in the range $(50\text{--}100) \times 10^{-6} \text{ K}^{-1}$, whereas microwave applications require materials with TCP within the range $\pm 10 \times 10^{-6} \text{ K}^{-1}$. One way of preparing low-TCP materials based on the compounds in question is by adding a negative-TCP phase to ensure permittivity thermocompensation [3]. Moreover, such additives must be nonreactive with the other components of the material. As a negative-TCP additive, we used CaTiO₃ (perovskite), which is known to have TCP = $-900 \times 10^{-6} \text{ K}^{-1}$ [3, 8–10]. Since this compound has high dielectric permittivity (on the order of 160), even

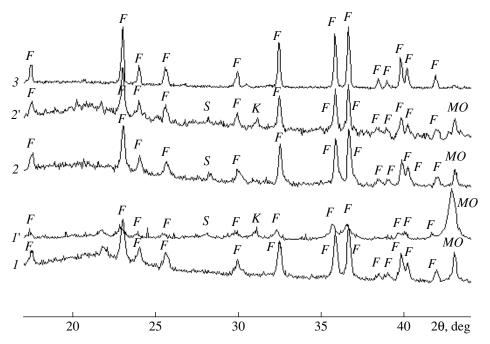


Fig. 1. XRD patterns of samples prepared by reacting (I-3) 2MgO + SiO₂ and (I', 2') 2MgCO₃ + SiO₂ mixtures at (I, I') 1000, (2, 2') 1200, and (3) 1350°C; $F = \text{Mg}_2\text{SiO}_4$, $S = \text{MgSiO}_3$ (protoenstatite), $K = \text{MgSiO}_3$ (clinoenstatite), MO = MgO.

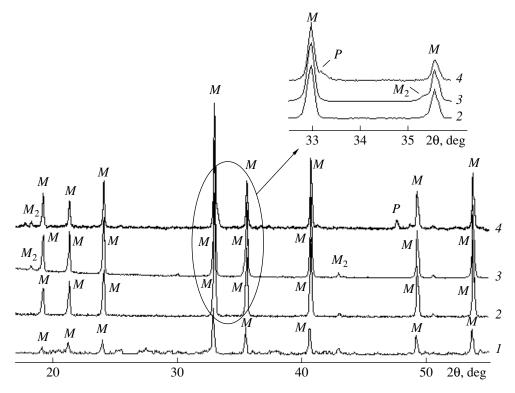


Fig. 2. XRD patterns of samples prepared by reacting MgO + TiO₂ mixtures at (1) 1000, (2) 1200, and (3, 4) 1350°C; (4) mixture containing 8 mol % CaTiO₃ additions; $M_2 = \text{Mg}_2\text{TiO}_4$, $P = \text{CaTiO}_3$, $M = \text{MgTiO}_3$. Inset: strongest reflections from Mg₂TiO₄ and CaTiO₃.

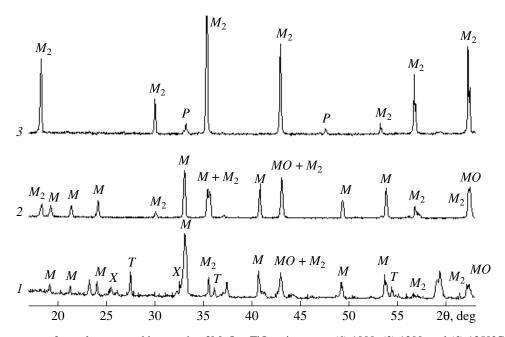


Fig. 3. XRD patterns of samples prepared by reacting $2MgO + TiO_2$ mixtures at (1) 1000, (2) 1200, and (3) 1350°C; (3) mixture containing 2 mol % CaO additions; $M_2 = Mg_2TiO_4$, $P = CaTiO_3$, $M = MgTiO_3$, MO = MgO, $T = TiO_2$.

small $CaTiO_3$ additions may increase the permittivity of the materials in question to 10–20, which is of practical importance in a number of engineering applications [4–7].

Table 1 summarizes our results for a number of low-TCP materials based on MgO–TiO₂–SiO₂. CaTiO₃ additions are seen to ensure efficient permittivity thermocompensation and to reduce the sintering tempera-

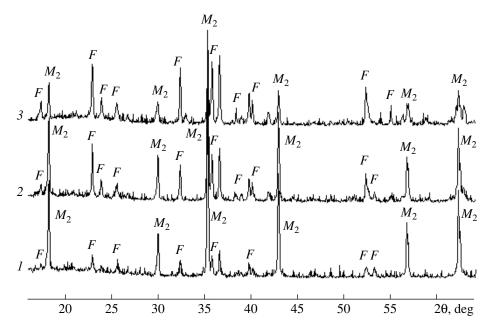


Fig. 4. XRD patterns of polycrystalline (1 - x)Mg₂SiO₄-xMg₂TiO₄samples sintered at 1350°C: x = (1) 0.75, (2) 0.5, (3) 0.25; $F = \text{Mg}_2\text{SiO}_4$, $M_2 = \text{Mg}_2\text{TiO}_4$.

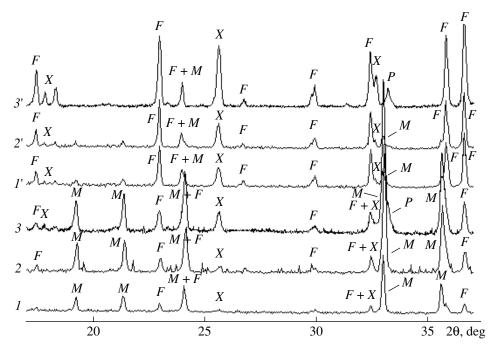


Fig. 5. XRD patterns of polycrystalline (1 - x)Mg₂SiO₄-xMgTiO₃ samples heat-treated at (I, I') 1000 and (2, 2', 3, 3') 1350°C; x = (I-3) 0.75, (I'-3') 0.25; (3, 3') mixture containing 6 mol % CaTiO₃; $F = \text{Mg}_2\text{SiO}_4$, $M = \text{Mg}_2\text{TiO}_4$, $X = \text{MgTi}_2\text{O}_5$, $P = \text{CaTiO}_3$.

ture by 50–100°C. The materials possess good temperature stability of permittivity, low dielectric losses, and ε in the range 15–25.

The dielectric properties of composites based on $(1-x)Mg_2SiO_4-xMg_2TiO_4$ and $(1-x)Mg_2SiO_4-xMgTiO_3$ are summarized in Table 2. These results

demonstrate that we obtained low-microwave-loss materials with permittivities in the range 10–20, depending on the phase composition of the ceramics. Note that the presence of MgTi₂O₅ markedly raises (by a factor of 2–3) dielectric losses in the ceramics (Table 2). The MgO–TiO₂–SiO₂ composites feature low sintering

Starting mixture	t _{sint} , °C	ε	$TCP \times 10^6$, K^{-1}	$Q = 1/\tan \delta$	Phase composition
$Mg_2TiO_4 + 0.05 CaTiO_3$	1450	22	+8	4000	Mg ₂ TiO ₄ , CaTiO ₃
$MgTiO_3 + 0.05 CaTiO_3$	1400	20	-5	5000	MgTiO ₃ , CaTiO ₃
$Mg_2SiO_4 + 0.1 CaTiO_3$	1450	12	+20	3500	Mg ₂ SiO ₄ , CaTiO ₃
$MgTi_2O_5 + 0.06 CaTiO_3$	1350	30	+30	1000	MgTi ₂ O ₅ , MgTiO ₃ , TiO ₂ , CaTiO ₃

Table 1. 10-GHz dielectric properties and phase composition of materials based on MgO-TiO₂-SiO₂

Table 2. 10-GHz dielectric properties and phase composition of composites based on $(1 - x)Mg_2SiO_4 - xMgTiO_3$ and $(1 - x)Mg_2SiO_4 - xMg_2TiO_4$

Starting mixture	t _{sint} , °C	ε	$TCP \times 10^6, K^{-1}$	$Q = 1/\tan \delta$	Phase composition
$\overline{0.75~{ m Mg}_2{ m SiO}_4 + 0.25~{ m MgTiO}_3 + 0.06~{ m CaTiO}_3}$	1380	10	-5	1800	Mg ₂ SiO ₄ , MgTi ₂ O ₅ , MgTiO ₃ ,CaTiO ₃
$0.5~\mathrm{Mg_2SiO_4} + 0.5~\mathrm{MgTiO_3} + 0.06~\mathrm{CaTiO_3}$	1380	12	+5	4000	Mg ₂ SiO ₄ , MgTiO ₃ , MgTi ₂ O ₅ , CaTiO ₃
$0.75~{ m Mg_2SiO_4} + 0.25~{ m MgTiO_3} + 0.06~{ m CaTiO_3}$	1350	15	-8	5000	Mg ₂ SiO ₄ , MgTiO ₃ , MgTi ₂ O ₅ , CaTiO ₃
$0.5~\mathrm{Mg_2SiO_4} + 0.5~\mathrm{MgTiO_3} + 0.1~\mathrm{CaTiO_3}$	1370	12.5	+15	3000	MgTiO ₃ , MgTi ₂ O ₅ , Mg ₂ SiO ₄ , CaTiO ₃
$0.25 \text{ Mg}_2 \text{SiO}_4 + 0.75 \text{ Mg}_2 \text{TiO}_4 + 0.06 \text{ CaTiO}_3$	1400	14.5	-10	4000	Mg ₂ SiO ₄ , Mg ₂ TiO ₄ , CaTiO ₃
$0.5 \text{ Mg}_2 \text{SiO}_4 + 0.5 \text{ Mg}_2 \text{TiO}_4 + 0.06 \text{ CaTiO}_3$	1400	12.5	-5	3000	Mg ₂ TiO ₄ , Mg ₂ SiO ₄ , CaTiO ₃

temperatures (<1400°C), high temperature stability of properties (owing to the effective thermocompensation upon the introduction of small CaTiO₃ additions), and low dielectric losses. They are potentially attractive for various electronic applications.

CONCLUSIONS

We studied chemical interactions of Mg₂SiO₄ with Mg₂TiO₄ and MgTiO₃ and identified conditions under which the MgTi₂O₅ phase (having an adverse effect on microwave losses) is formed in the MgO–TiO₂–SiO₂ system. Our results demonstrate that CaTiO₃ additions reduce the sintering temperature of the ceramics studied by 50–100°C and ensure efficient permittivity thermocompensation. The synthesized materials offer low microwave losses and dielectric permittivities in the range 10–20.

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